

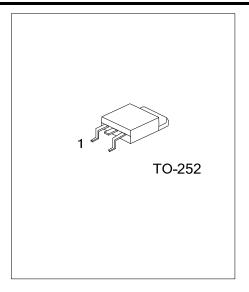
UNISONIC TECHNOLOGIES CO., LTD

2N65K **Power MOSFET**

2A, 650V N-CHANNEL **POWER MOSFET**

DESCRIPTION

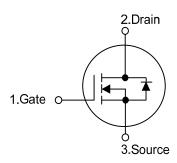
The UTC 2N65K is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.



FEATURES

- * $R_{DS(ON)} = 5.0\Omega$ @ $V_{GS} = 10V$
- * Ultra Low gate charge (typical 9.0nC)
- * Low reverse transfer capacitance (C_{RSS} = typical 5.0 pF)
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

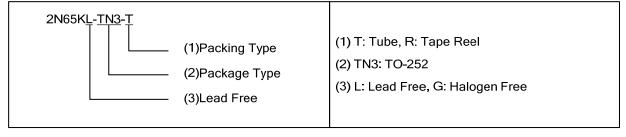
SYMBOL



ORDERING INFORMATION

Ordering Number		Dealtage	Pin Assignment			Daakina	
Lead Free	Halogen Free	Package	1	2	3	Packing	
2N65KL-TN3-R	2N65KG-TN3-R	TO-252	G	D	S	Tape Reel	
2N65KL-TN3-T	2N65KG-TN3-T	TO-252	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



www.unisonic.com.tw 1 of 6

■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	650	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Avalanche Current (Note 2)		I _{AR}	2.0	Α	
Drain Current	Continuous	I _D	2.0	Α	
	Pulsed (Note 2)	I _{DM}	8.0	Α	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	60	mJ	
	Repetitive (Note 2)	E _{AR}	4.5	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns	
Power Dissipation		P_{D}	28	W	
Junction Temperature		TJ	+150	°C	
Operating Temperature		T_OPR	-55 ~ +150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating : Pulse width limited by T_{J}
- 3. L=64mH, I_{AS} =2.0A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD}\leq 2.4A$, di/dt $\leq 200A/\mu s$, $V_{DD}\leq BV_{DSS}$, Starting T_J = 25°C

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	110	°C/W	
Junction to Case	θ _{Jc}	4.53	°C/W	

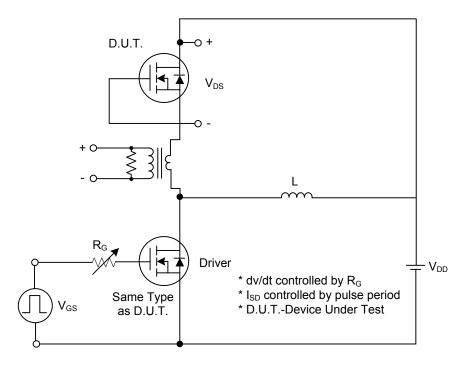
■ ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	650			V	
Drain-Source Leakage Current		I _{DSS}	$V_{DS} = 650V, V_{GS} = 0V$			10	μΑ	
Gate-Source Leakage Current	Forward		$V_{GS} = 30V, V_{DS} = 0V$			100	nA	
	Reverse	I_{GSS}	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA	
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_J$	I _D =250μA, Referenced to 25°C		0.4		V/°C	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		5.0	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	$V_{GS} = 10V, I_{D} = 1A$		5.0	6.0	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance	nput Capacitance		\/ =35\/ \/ =0\/		270	350	pF	
Output Capacitance		Coss	V _{DS} =25V, V _{GS} =0V, f =1MHz		40	50	pF	
Reverse Transfer Capacitance		C_{RSS}			5	7	pF	
SWITCHING CHARACTERISTIC	S							
Turn-On Delay Time		t _{D (ON)}			10	30	ns	
Turn-On Rise Time		t_R	$V_{DD} = 325V, I_D = 2.4A,$		25	60	ns	
Turn-Off Delay Time		$t_{D(OFF)}$	R _G =25Ω (Note 1, 2)		20	50	ns	
Turn-Off Fall Time		t_{F}			25	60	ns	
Total Gate Charge		Q_G	V _{DS} =520V, V _{GS} =10V,		9.0	11	nC	
Gate-Source Charge		Q_GS	I _D =2.4A (Note 1, 2)		1.6		nC	
Gate-Drain Charge		Q_GD	ID-2.4A (Note 1, 2)		4.3		nC	
DRAIN-SOURCE DIODE CHARACTERISTICS								
Drain-Source Diode Forward Voltage		V_{SD}	$V_{GS} = 0 \text{ V}, I_{SD} = 2.0 \text{ A}$			1.4	V	
Continuous Drain-Source Current		I_{SD}				2.0	Α	
Pulsed Drain-Source Current		I _{SM}				8.0	Α	
Reverse Recovery Time		t _{rr}	V _{GS} = 0 V, I _{SD} = 2.4A, di/dt = 100 A/μs (Note1)		180		ns	
Reverse Recovery Charge		Q_{RR}			0.72		μC	

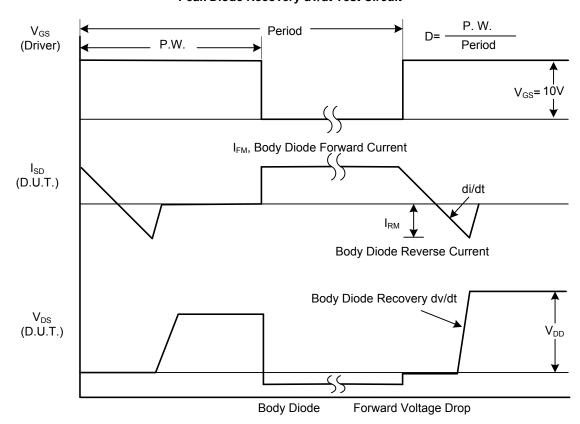
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle≤2%

^{2.} Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

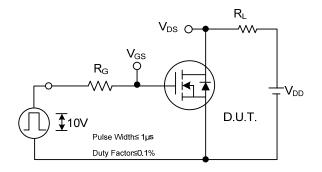


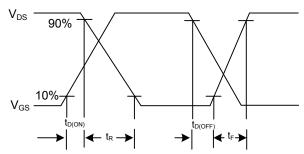
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

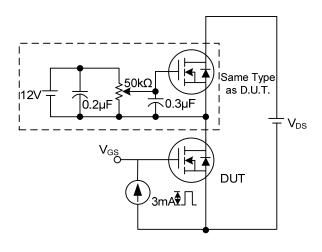
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

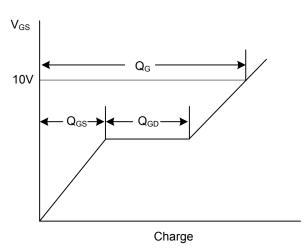




Switching Test Circuit

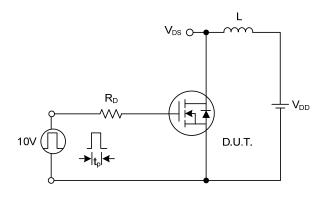
Switching Waveforms

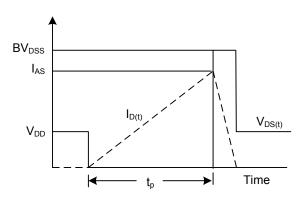




Gate Charge Test Circuit

Gate Charge Waveform

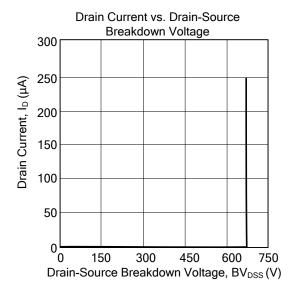


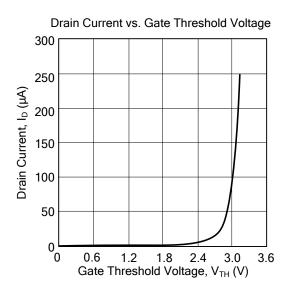


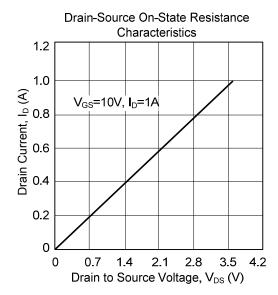
Unclamped Inductive Switching Test Circuit

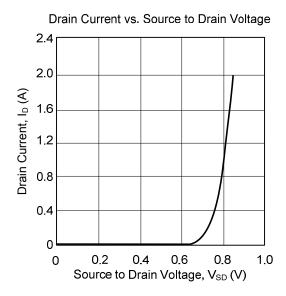
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS









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